

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10727124			
<b>Filing Date:</b>	03-Dec-2003			
<b>Title of Invention:</b>	Method of manufacturing microneedle structures using soft lithography and photolithography			
<b>First Named Inventor/Applicant Name:</b>	Francisco Arias			
<b>Filer:</b>	Flavio Miguel Rose			
<b>Attorney Docket Number:</b>	2335-0108.10			
Filed as Small Entity				
<b>Utility      Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
Independent claims in excess of 3	2201	2	105	210
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	2252	1	230	230
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>440</b>